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PATENT NUMBER and ISSUE DATE

U.S. UTILITY Patent Application

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1	10081976	02/20/2002	385	43	2874	VALENCIA	
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*		S: Oh Min-		etterman Harol	d; Steier W	filliam; Michael Joseph	
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TITLE: Tapered waveguide interconnection structure and method of fabricating the same U.S.DEPT. OF COMM. (PAT. & TMPTO-435LIRev. 12-34)							
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NOTICE OF ALLOWANCE MAILED			CLAIMS ALLOWED			
		Assistant Examiner	Total Claims		Print Claim for D.G	
ISSUE FEE			DRAWING			
Amount Due	Date Paid	7	Sheets Drwg.	Figs.Drwg	Print Fig.	
TERMINAL DISCLAMER		Primary Examiner				
		PREPARED FOR ISSUE	Application Examiner			
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